# 200GBASE-FR4 QSFP56 Optical Transceiver

#### **Product Features**

- Compliant with IEEE 802.3bs and Annex 120E 200GAUI-4 C2M
- Compliant with CMIS 4.0
- 4x26.5625GBd PAM4 transmitter and PAM4 receiver
- Optical Transmitter: CWDM EA-DFB
- Optical Receiver: PIN photo detector
- 4 channels monitor photo detector
- Single +3.3V power supply, Power consumption < 7W
- Operation case temperature of 0~70°C
- Duplex LC connector
- Maximum link length of 2km on SMF
- RoHS10 compliance, and Class 1 laser safety
- Application: Data center, enterprise, and telecom applications

### **Absolute Maximum Ratings**

Parameter	Unit	Min.	Typical	Max.	Notes
Storage Temperature	°C	-40		85	
Operating Relative Humidity	%	0		85	
Power Supply Voltage	V	-0.5		3.63	

#### **Recommended Operating Conditions**

Parameter	Unit	Min.	Typical	Max.	Notes
Operating Case Temperature	°C	0		70	note1
Power Supply Voltage	V	3.135	3.3	3.465	
Power Supply Current	Α			2.2	
Power Consumption	W			7	
Bit Rate	Gbps		212.5		

Note1, Case Temperature here is depending on module case around TOSA, please do remember it is NOT the environmental temperature.

#### **Electrical Characteristics**

Parameter	Unit	Min.	Typical	Max.	Note
Transmitter					

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Signaling rate per lane (range)		2	26.5625 ± 100	ppm	TP1
Differential pk-pk input voltage tolerance (min)	mV	900	-	-	TP1a
Date Differential Impedance	Ω	90	100	110	
	Receiv	ver .			
Signaling rate per lane (range)		26.5625 ± 100 ppm TP			TP4
Differential peak-to-peak output voltage (max)	mV	-	-	900	TP4
Date Differential Impedance		90	100	110	

## **Optical Characteristics**

All performance is specified at whole working temperature and conditions

Parameter	Unit	Min.	Typical	Max.	Note
	Tran	smitter			
Signaling rate, each lane	GBd	26			
Modulation Format			PAM4		
	nm	1264.5	1271	1277.5	
Lana vysvalanatka (oznas)	nm	1284.5	1291	1297.5	
Lane wavelengths (range)	nm	1304.5	1311	1317.5	
	nm	1324.5	1331	1337.5	
Side-mode suppression ratio (SMSR), (min)	dB	30			
Total average launch power (max)	dBm	10.7			
Average Launch Power, each lane	dBm	-4.2		4.7	
Outer Optical Modulation Amplitude	10				
(OMAouter), each lane	dBm	-1.2		4.5	
Difference in launch power between any	10				
two lanes (OMAouter) (max)	dB			4	
Launch power in OMAouter minus					
TDECQ, each lane (min):	dBm	-2.6			
for extinction ratio 2 4.5 dB	dBm	-2.5			
for extinction ratio < 4.5 dB					
Transmitter and dispersion eye closure for PAM4 (TDECQ), each lane	dB			3.3	
Average Launch power of OFF transmitter,					
each lane	dBm			-30	
Extinction Ratio, each lane	dB	3.5			
Optical Return Loss Tolerance	dB			16.5	
RIN16.5OMA (max)	dB/Hz			-132	
Transmitter reflectance (max)	dB			-26	
	Rece	eiver	<u> </u>	<u> </u>	
	rate, each lane GBd 26.5625 ± 100 ppm				

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Modulation Format			PAM4			
	nm	1264.5	1271	1277.5		
Lane wavelengths (range)	nm	1284.5	1291	1297.5		
Lane wavelengths (range)	nm	1304.5	1311	1317.5		
	nm	1324.5	1331	1337.5		
Damage threshold (min)	dBm	5.7				
Average Receive Power, each lane	dBm	-8.2		4.7		
Receive Power (OMAouter), each lane	dBm			4.5		
Difference in receive power between any two lanes (OMAouter) (max)	dB			4.1		
Receiver Reflectance	dB			-26		
Stressed Receiver Sensitivity (OMAouter), each lane	dBm			-3.6	1	
Receiver sensitivity (OMAouter), each lane (max)	dBm			-6		
Conditions of stressed receiver sensitivity te	est:					
Stressed eye closure for PAM4 (SECQ), lane under test	dB	3.3				
OMAouter of each aggressor lane	dBm	0.5				
LOS Assert	dBm	-20				
LOS De-Assert	dBm			-10.3		
LOS Hysteresis	dB	0.5				

#### Note:

1. BER=2.4E-4; PRBS31Q@26.5625GBd. Pre-FEC

# Pin Assignment and Description

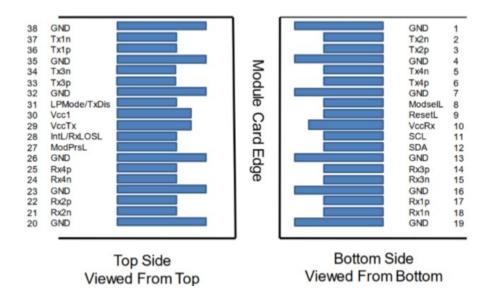


Figure 1: Module contact definition

#### **PIN Definition**

Pad	Logic	Symbol	Description	Plug Sequen	Notes
1		GND	Ground	ce 1	1
2	CML-I	Tx2n	Transmitter Inverted Data Input	3	
3	CML-I	Тх2р	Transmitter Non-Inverted Data Input	3	
4		GND	Ground	1	1
5	CML-I	Tx4n	Transmitter Inverted Data Input	3	
6	CML-I	Tx4p	Transmitter Non-Inverted Data Input	3	
7		GND	Ground	1	1
8	LVTTL-I	ModSelL	Module Select	3	
9	LVTTL-I	ResetL	Module Reset	3	
10		VccRx	+3.3V Power Supply Receiver	2	2
11	LVCMOS- I/O	SCL	2-wire serial interface clock	3	
12	LVCMOS- I/O	SDA	2-wire serial interface data	3	
13		GND	Ground	1	1
14	CML-O	Rx3p	Receiver Non-Inverted Data Output	3	
15	CML-O	Rx3n	Receiver Inverted Data Output	3	
16		GND	Ground	1	1
17	CML-O	Rx1p	Receiver Non-Inverted Data Output	3	
18	CML-O	Rx1n	Receiver Inverted Data Output	3	
19		GND	Ground	1	1



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20		GND	Ground	1	1
21	CML-O	Rx2n	Receiver Inverted Data Output	3	
22	CML-O	Rx2p	Receiver Non-Inverted Data Output	3	
23		GND	Ground	1	1
24	CML-O	Rx4n	Receiver Inverted Data Output	3	
25	CML-O	Rx4p	Receiver Non-Inverted Data Output	3	
26		GND	Ground	1	1
27	LVTTL-O	ModPrsL	Module Present	3	
28	LVTTL-O	IntL/RxL	Interrupt. Optionally configurable as RxLOSL via	3	4
20	LVIIL-O	OSL	the management interface (SFF-8636)	,	7
29		VccTx	+3.3V Power supply transmitter	2	2
30		Vcc1	+3.3V Power supply	2	2
31	LVTTL-I	LPMode/	Low Power Mode. Optionally configurable as	3	3
31	LVIIL-I	TxDis	TxDis via the management interface (SFF-8636)	3	3
32		GND	Ground	1	1
33	CML-I	Тх3р	Transmitter Non-Inverted Data Input	3	
34	CML-I	Tx3n	Transmitter Inverted Data Input	3	
35		GND	Ground	1	1
36	CML-I	Tx1p	Transmitter Non-Inverted Data Input	3	
37	CML-I	Tx1n	Transmitter Inverted Data Input	3	
38	_	GND	Ground	1	1

Note 1: GND is the symbol for signal and supply (power) common for the module. All are common within the module and all module voltages are referenced to this potential unless otherwise noted. Connect these directly to the host board signal-common ground plane.

Note 2: VccRx, Vcc1 and VccTx shall be applied concurrently and be internally connected within the module in any combination. Vcc contacts in SFF-8662 and SFF-8672 each have a steady state current rating of 1A.

Note 3: Pin31 TxDis (fast mode) is available.

Note 4: Pin 28 RxLOS (fast mode) is available.

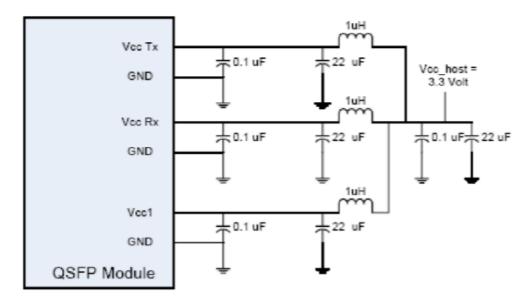
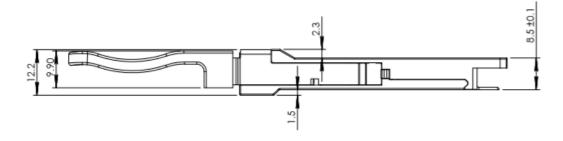


Figure 2: Recommended Host Board Power Supply Filtering

#### **OUTLINES**



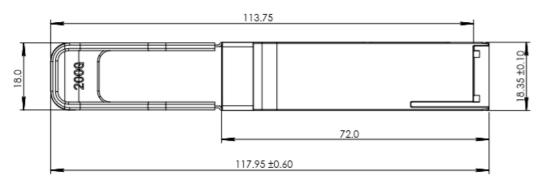


Figure 3. Mechanical Outline

## **Digital Diagnostic Functions**

Parameter	Units	Error	NOTES
Temperature Monitor	°C	±3	1LSB=1/256°C
Supply Voltage Monitor	V	±0.1	1LSB=100uV
Bias Current Monitor	mA	±10%	1LSB=2uA
TX Power Monitor	dB	±3	1LSB=0.1uW
RX Power Monitor	dB	±3	1LSB=0.1uW

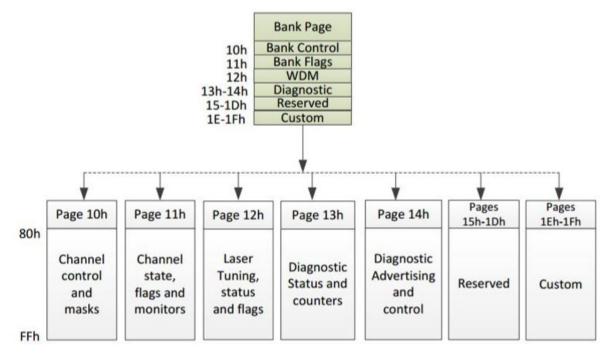


Figure 5. Additional Supported Bank Page Memory Map

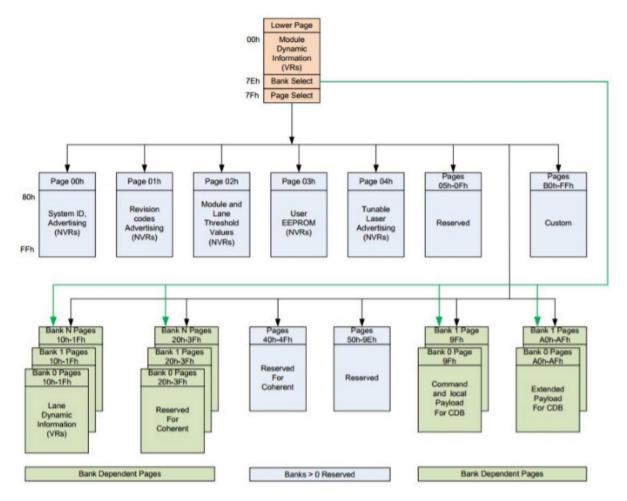


Figure 6. CMIS Bank Page Memory Map

#### **ESD**

This transceiver is specified as ESD threshold 1kV for high speed data pins and 2kV for all other electrical input pins, tested per MIL-STD-883, Method 3015.4 /JESD22-A114-A (HBM). However, normal ESD precautions are still required during the handling of this module. This transceiver is shipped in ESD protective packaging. It should be removed from the packaging and handled only in an ESD protected environment.

#### **Laser Safety**

This is a Class 1 Laser Product according to IEC 60825-1:2007. This product complies with 21 CFR 1040.10 and 1040.11 except for deviations pursuant to Laser Notice No. 50, dated (June 24, 2007).

### **Ordering Information**

Ordering P/Ns	Description				
DDCCjj-KLCA	2km, 4x50G QSFP56 FR4, CWDM4 1271/1291/1311/1331nm, LC/UPC optical				
	interface, commercial temperature				



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